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December 1998



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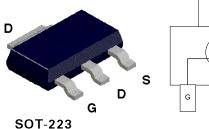
NDT456P P-Channel Enhancement Mode Field Effect Transistor

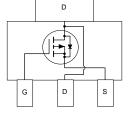
General Description

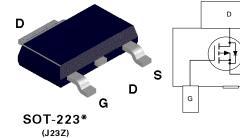
Power SOT P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management, battery powered circuits, and DC motor control.

Features

- $\label{eq:constraint} \begin{array}{c} \bullet & -7.5 \text{ A}, \ -30 \ \text{V}. \ \text{R}_{_{\text{DS}(\text{ON})}} = 0.030 \ \Omega \ @ \ \text{V}_{_{\text{GS}}} = -10 \ \text{V} \\ & \text{R}_{_{\text{DS}(\text{ON})}} = 0.045 \ \Omega \ @ \ \text{V}_{_{\text{GS}}} = -4.5 \ \text{V}. \end{array}$
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.





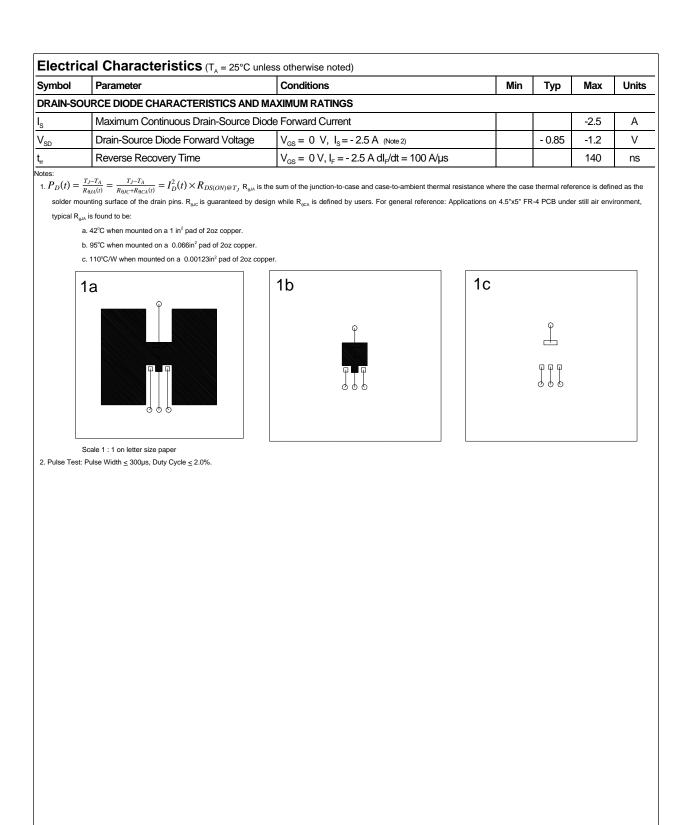


Absolute Maximum Ratings T₄ = 25°C unless otherwise noted

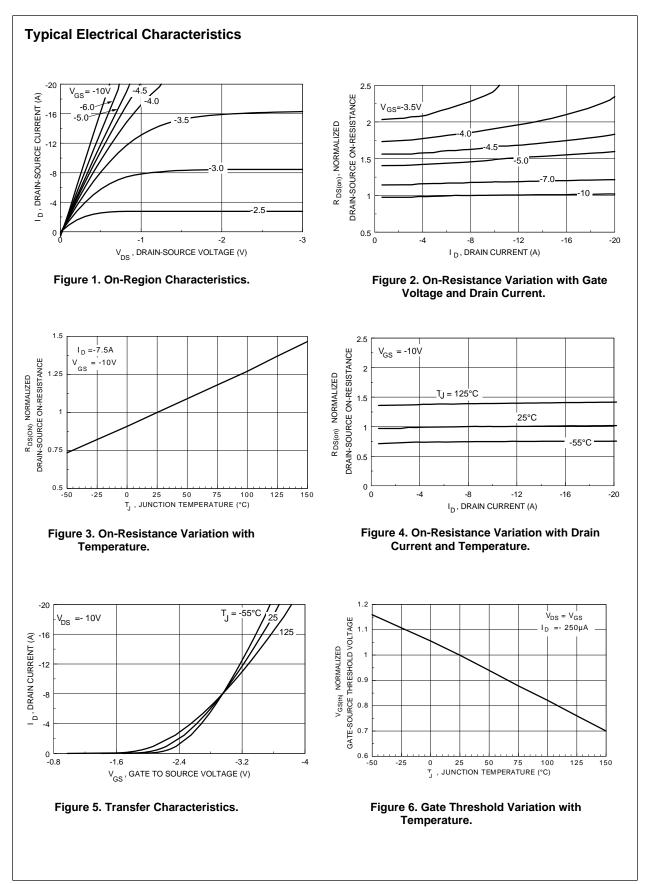
Symbol	Parameter		NDT456P	Units	
V _{DSS}	Drain-Source Voltage		-30	V	
V _{GSS}	Gate-Source Voltage		±20	V	
I _D	Drain Current - Continuous	(Note 1a)	±7.5	A	
	- Pulsed		±20		
P _D	Maximum Power Dissipation	(Note 1a)	3	W	
		(Note 1b)	1.3		
		(Note 1c)	1.1		
T _J ,T _{STG}	Operating and Storage Temperature Range		-65 to 150	°C	
THERMA	L CHARACTERISTICS				
R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1a)		42	°C/W	
R _{θJC}	Thermal Resistance, Junction-to-Ca	SE (Note 1)	12	°C/W	

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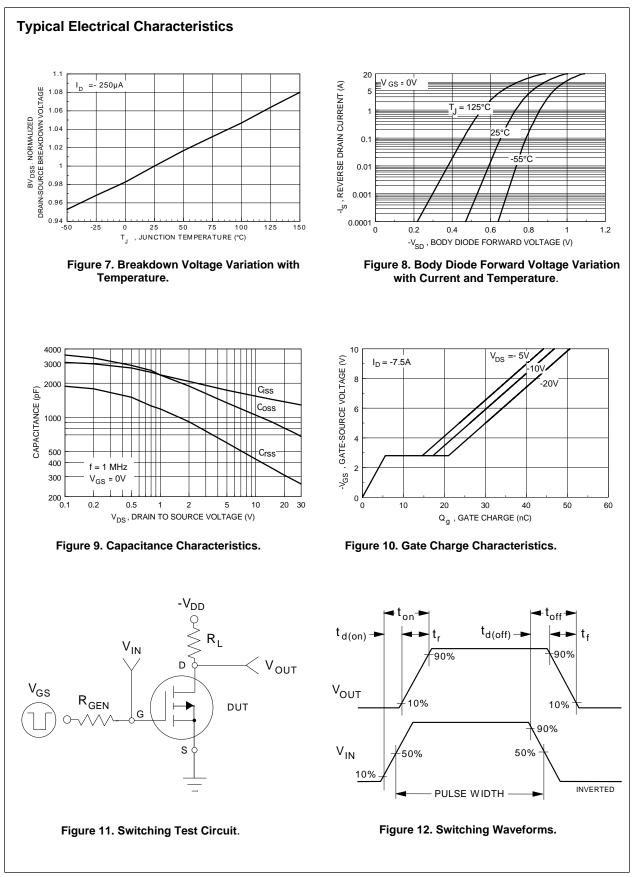
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						•
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		-30			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$				-1	μA
			T _J =55°C			-10	μA
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-1	-1.5	-3	V
			T _J =125°C	-0.5	-1.1	-2.6	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -7.5 \text{ A}$			0.026	0.03	Ω
			T _J =125°C		0.035	0.054	
l		$V_{GS} = -4.5 \text{ V}, I_{D} = -6 \text{ A}$			0.041	0.045	
I _{D(on)}	On-State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$		-20			Α
		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$		-10			
G _{fs}	Forward Transconductance	$V_{GS} = -10 \text{ V}, \ I_{D} = -7.5 \text{ A}$			13		S
DYNAMIC	CHARACTERISTICS			-		÷	
C _{iss}	Input Capacitance	$V_{DS} = -15 V, V_{GS} = 0 V,$ f = 1.0 MHz			1440		pF
C _{oss}	Output Capacitance				905		pF
C _{rss}	Reverse Transfer Capacitance				355		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = -15 \text{ V}, \text{ I}_{D} = -7 \text{ A},$ $V_{GEN} = -10 \text{ V}, \text{ R}_{GEN} = 12 \Omega$			10	20	ns
t,	Turn - On Rise Time				65	120	ns
t _{D(off)}	Turn - Off Delay Time				70	130	ns
t,	Turn - Off Fall Time				70	130	ns
Q _g	Total Gate Charge	$V_{DS} = -10 V,$			47	67	nC
Q _{gs}	Gate-Source Charge	$I_{\rm D} = -7.5 \text{ A}, \text{ V}_{\rm GS} = -10 \text{ V}$			5		nC
Q_{gd}	Gate-Drain Charge				12		nC

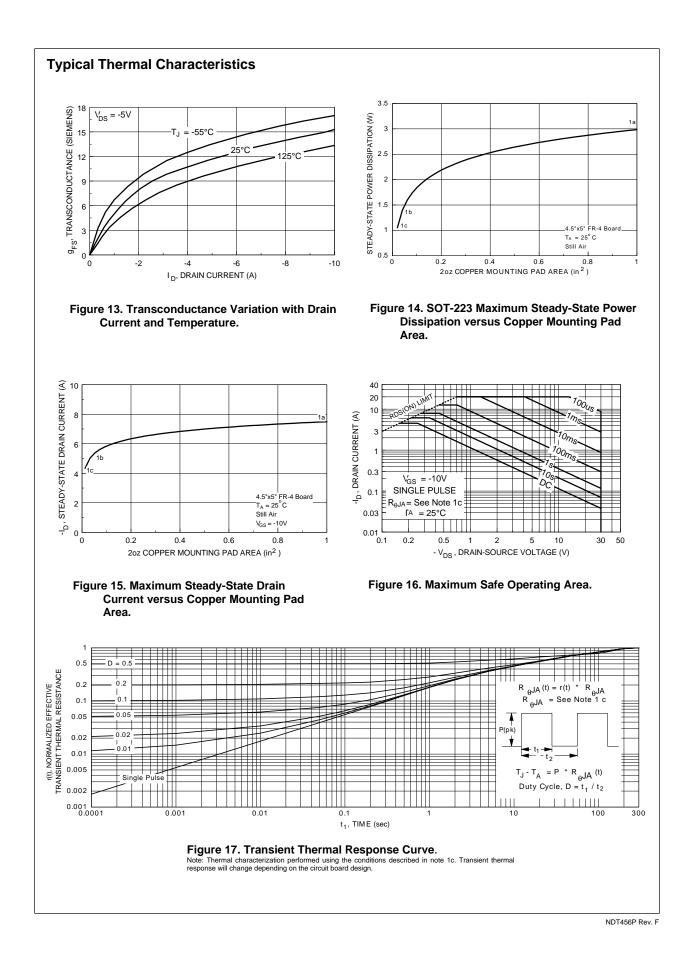


NDT456P Rev. F



NDT456P Rev. F





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